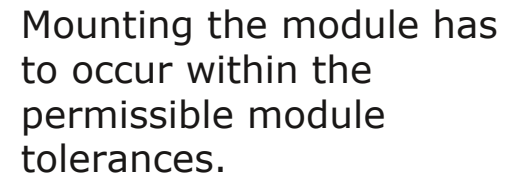


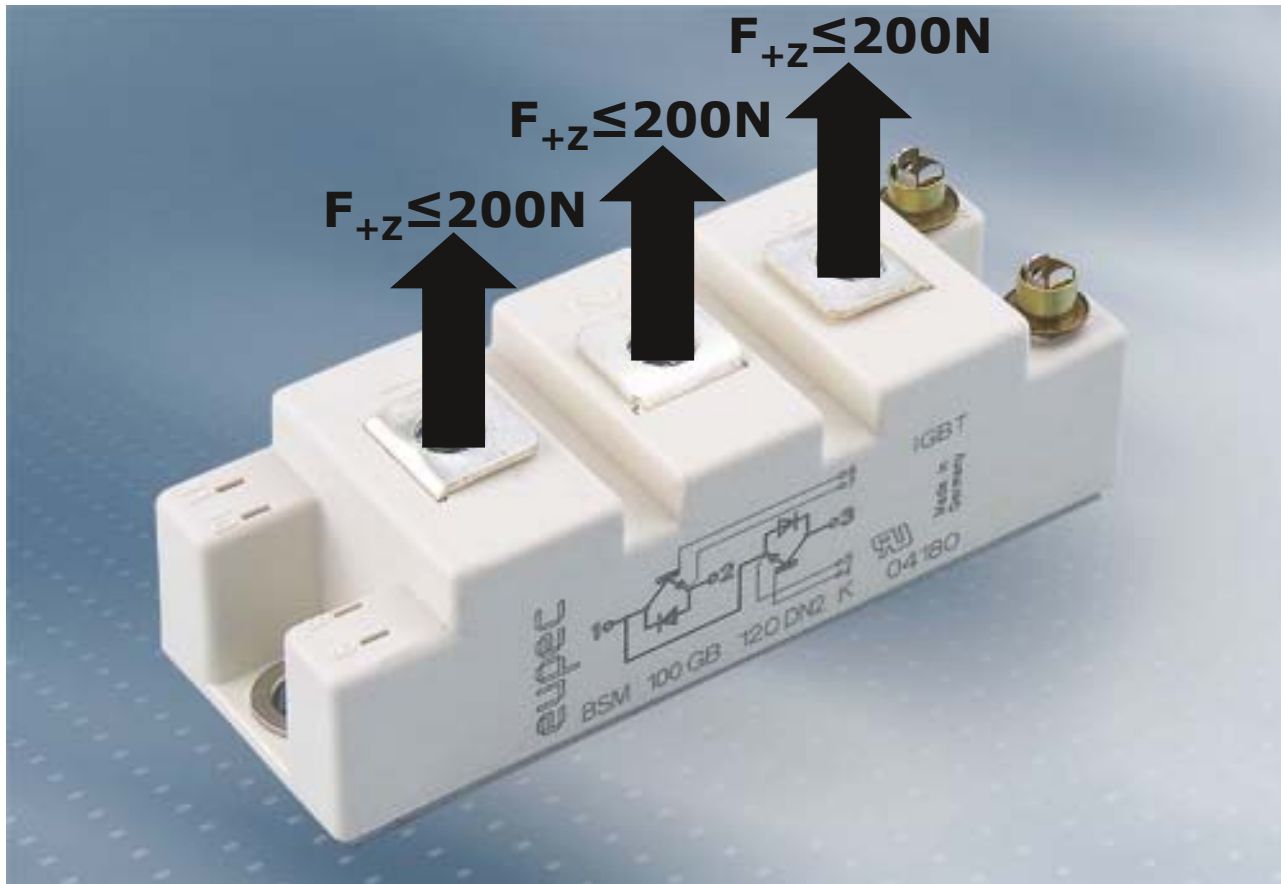
34mm Mounting Forces





Page 2

34mm Mounting - Pull Forces Power Terminals



The modules must to be mounted in such way that the resulting pull-forces during mounting per power terminal of the module are limited to $F_{+z} \leq 200\text{N}$. Pulling, shocking and/or vibrational forces at the power terminals have to be avoided. The connection must be done in nontensional conditions.

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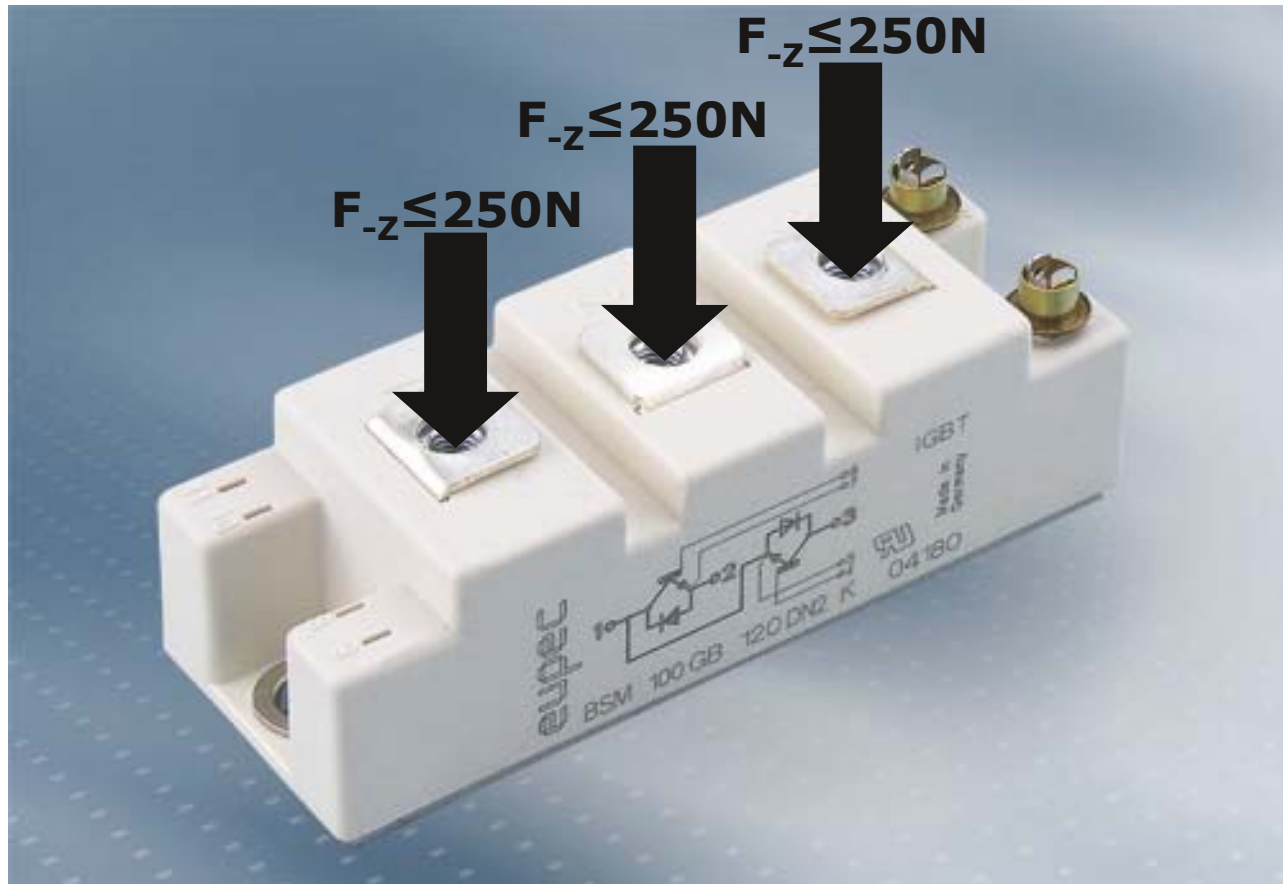
34mm Mounting - Pull Forces Control Terminals



The modules must to be mounted in such way that the resulting pull-forces during mounting per control terminal of the module are limited to $F_{+z} \leq 60\text{N}$. Pulling, shocking and/or vibrational forces at the power terminals have to be avoided. The connection must be done in nontensional conditions.

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34mm Mounting - Push Forces Power Terminals



The modules must to be mounted in such way that the resulting push-forces during mounting per power terminal of the module are limited to $F_z \leq 250\text{N}$. Pushing, shocking and/or vibrational forces at the power terminals have to be avoided. The connection must be done in nontensional conditions.

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34mm Mounting - Push Forces Control Terminals



The modules must to be mounted in such way that the resulting push-forces during mounting per control terminal of the module are limited to $F_{-z} \leq 60\text{N}$. Pushing, shocking and/or vibrational forces at the power terminals have to be avoided. The connection must be done in nontensional conditions.

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